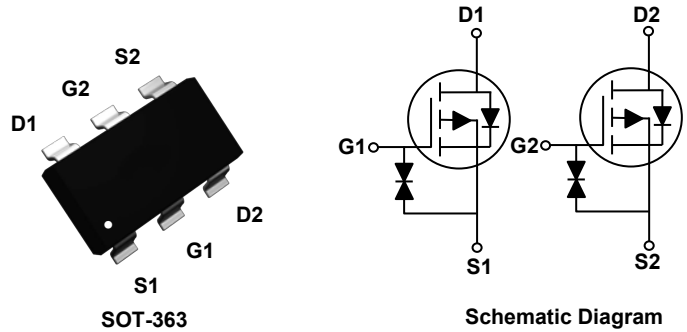


Main Product Characteristics

| | |
|--------------|-------------------|
| BV_{DSS} | -50V |
| $R_{DS(ON)}$ | 2.6Ω @-10V (Typ) |
| | 3.2Ω @-4.5V (Typ) |
| I_D | -0.18A |



Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The GSFK0501E utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supplies and a wide variety of other applications.

Absolute Maximum Ratings ($T_A=25^{\circ}C$ unless otherwise specified)

| Parameter | Symbol | Max. | Unit |
|---|-----------------|-------------|------|
| Drain-Source Voltage | V_{DS} | -50 | V |
| Gate-Source Voltage | V_{GS} | ±20 | V |
| Drain Current-Continuous ($T_A=25^{\circ}C$) | I_D | -0.18 | A |
| Drain Current-Continuous ($T_A=70^{\circ}C$) | | -0.14 | |
| Drain Current-Pulsed ($T_A=25^{\circ}C$) ¹ | I_{DM} | -1.2 | A |
| Power Dissipation ($T_A=25^{\circ}C$) | P_D | 0.3 | W |
| Power Dissipation ($T_A=70^{\circ}C$) | | 0.24 | |
| Thermal Resistance, Junction-to-Ambient | $R_{\theta JA}$ | 400 | °C/W |
| Operating Junction Temperature Range | T_J | -50 To +150 | °C |
| Storage Temperature Range | T_{STG} | -50 To +150 | °C |

Electrical Characteristics ($T_J=25^{\circ}\text{C}$ unless otherwise specified)

| Parameter | Symbol | Conditions | Min. | Typ. | Max. | Unit |
|---|---------------|--|------|------|----------|----------|
| Off Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS}=0V, I_D=-250\mu A$ | -50 | - | - | V |
| Zero Gate Voltage Drain Current, $T_A=25^{\circ}\text{C}$ | I_{DSS} | $V_{DS}=-50V, V_{GS}=0V$ | - | - | -1 | μA |
| Zero Gate Voltage Drain Current, $T_A=125^{\circ}\text{C}$ | | $V_{DS}=-40V, V_{GS}=0V$ | - | - | -100 | μA |
| Gate-Source Leakage Current | I_{GSS} | $V_{GS}=\pm 20V, V_{DS}=0V$ | - | - | ± 10 | μA |
| On Characteristics | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{GS}=V_{DS}, I_D=-250\mu A$ | -1.0 | -2.0 | -3.0 | V |
| Drain-Source On-State Resistance ² | $R_{DS(on)}$ | $V_{GS}=-10V, I_D=-0.15A$ | - | 2.6 | 4 | Ω |
| | | $V_{GS}=-4.5V, I_D=-0.15A$ | - | 3.2 | 6 | Ω |
| Dynamic and Switching Characteristics | | | | | | |
| Total Gate Charge | Q_g | $V_{DS}=-30V, V_{GS}=-10V, I_D=-0.2A$ | - | 0.53 | - | nC |
| Gate-Source Charge | Q_{gs} | | - | 0.14 | - | |
| Gate-Drain Charge | Q_{gd} | | - | 0.1 | - | |
| Turn-On Delay Time | $T_{d(on)}$ | $V_{DD}=-30V, V_{GS}=-10V, R_G=3.3\Omega, I_D=-0.1A$ | - | 1.6 | - | nS |
| Rise Time | T_r | | - | 5.2 | - | |
| Turn-Off Delay Time | $T_{d(off)}$ | | - | 12 | - | |
| Fall Time | T_f | | - | 6.1 | - | |
| Input Capacitance | C_{iss} | $V_{DS}=-25V, V_{GS}=0V, F=1\text{MHz}$ | - | 25.2 | - | pF |
| Output Capacitance | C_{oss} | | - | 5.9 | - | |
| Reverse Transfer Capacitance | C_{rss} | | - | 1.4 | - | |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| Source Drain Current (Body Diode) | I_{SD} | $T_A=25^{\circ}\text{C}$ | - | - | -0.18 | A |
| Diode Forward Voltage ² | V_{SD} | $V_{GS}=0V, I_{SD}=-0.1A, T_J=25^{\circ}\text{C}$ | - | - | -1.2 | V |

Note:

1. Repetitive rating: Pulsed width limited by maximum junction temperature.
2. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.

Typical Electrical and Thermal Characteristic Curves

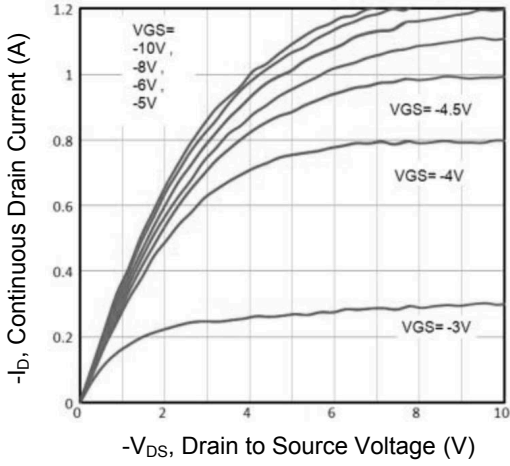


Figure 1. Typical Output Characteristics

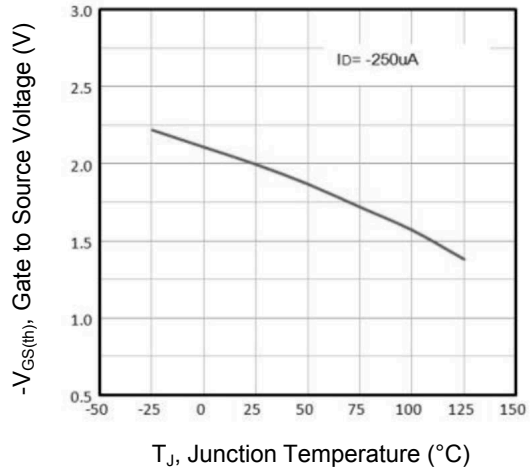


Figure 2. Normalized Threshold Voltage vs. T_J

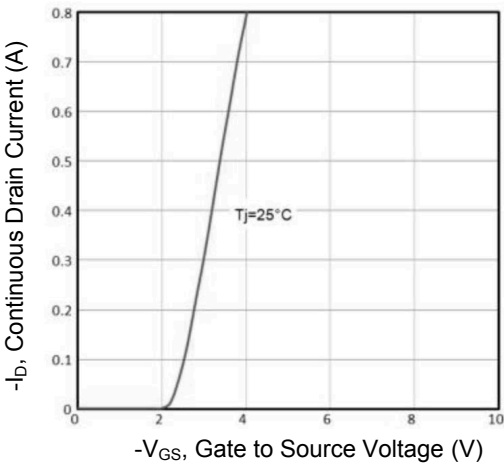


Figure 3. Typical Transfer Characteristics

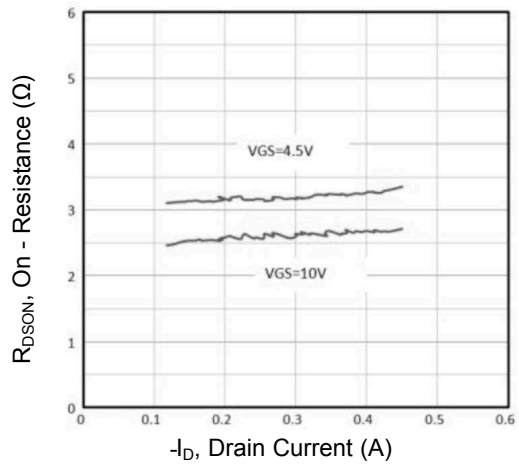


Figure 4. On-Resistance vs. Drain Current

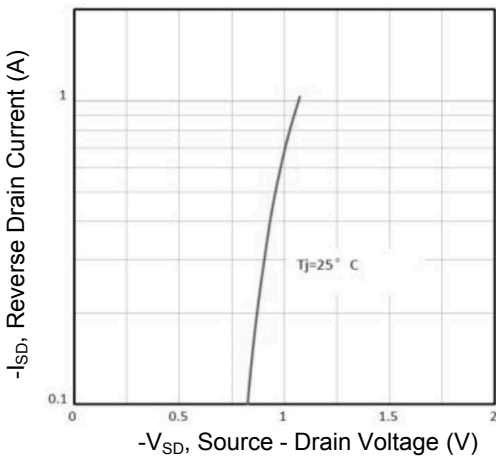


Figure 5. Typical Source - Drain Diode Forward Voltage

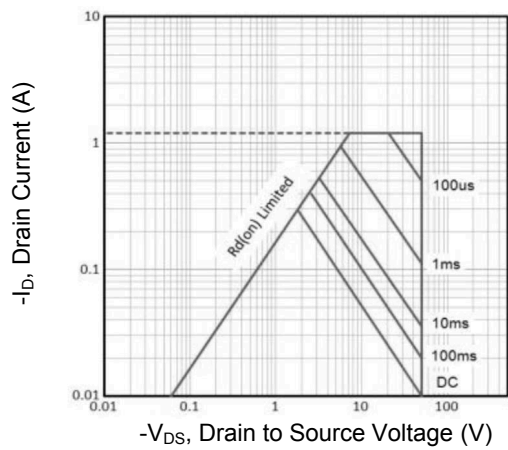


Figure 6. Maximum Safe Operating Area

Typical Electrical and Thermal Characteristic Curves

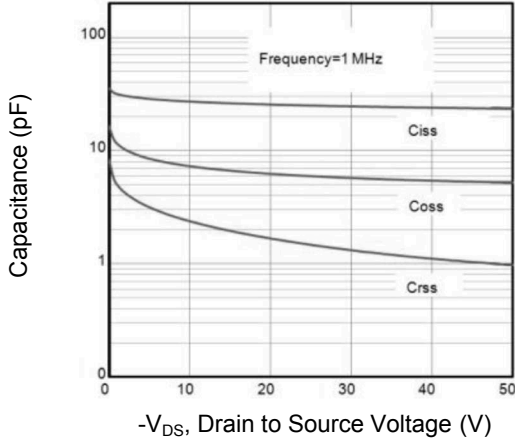


Figure 7. Typical Capacitance vs. Drain - Source Voltage

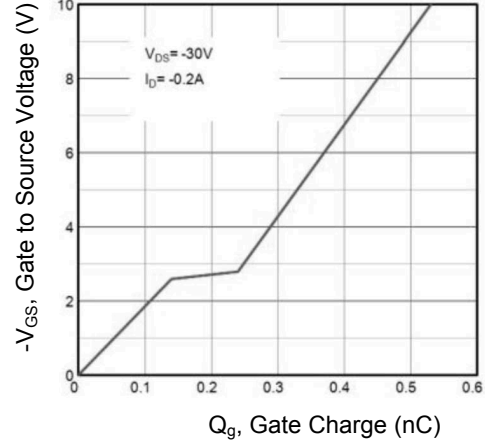


Figure 8. Gate Charge Characteristics

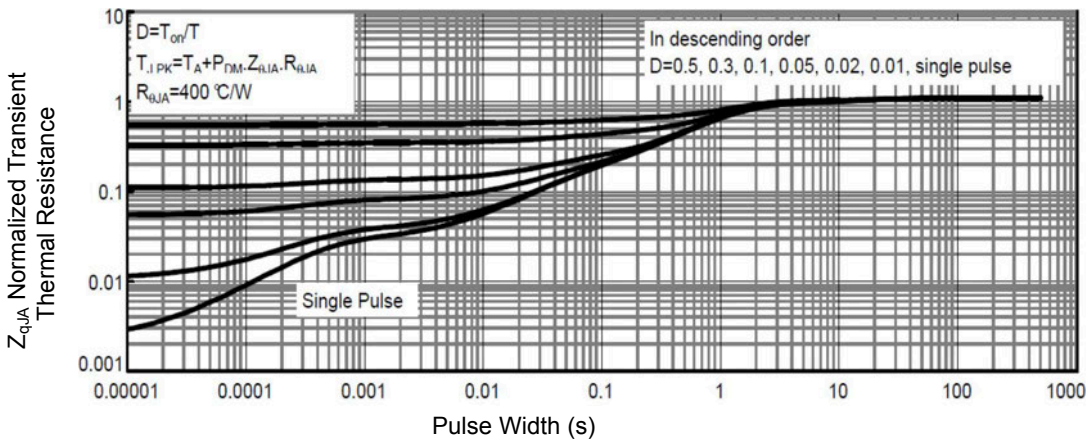


Figure 9. Normalized Maximum Transient Thermal Impedance

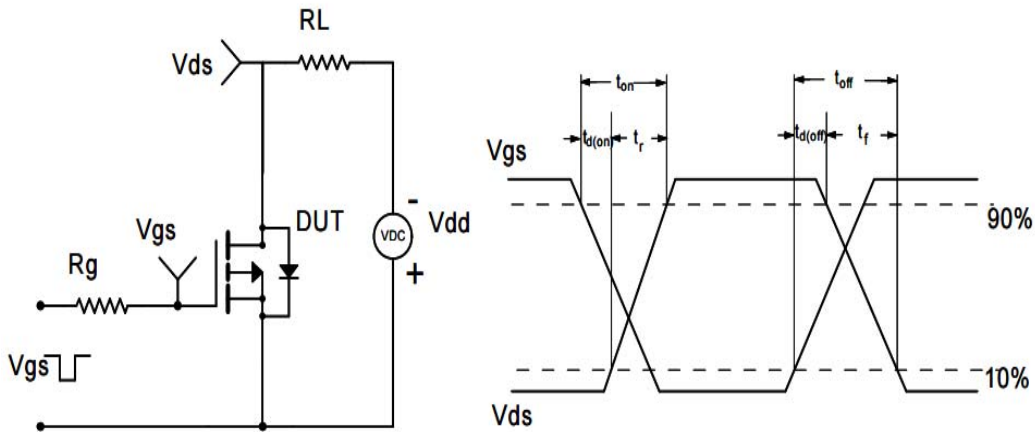
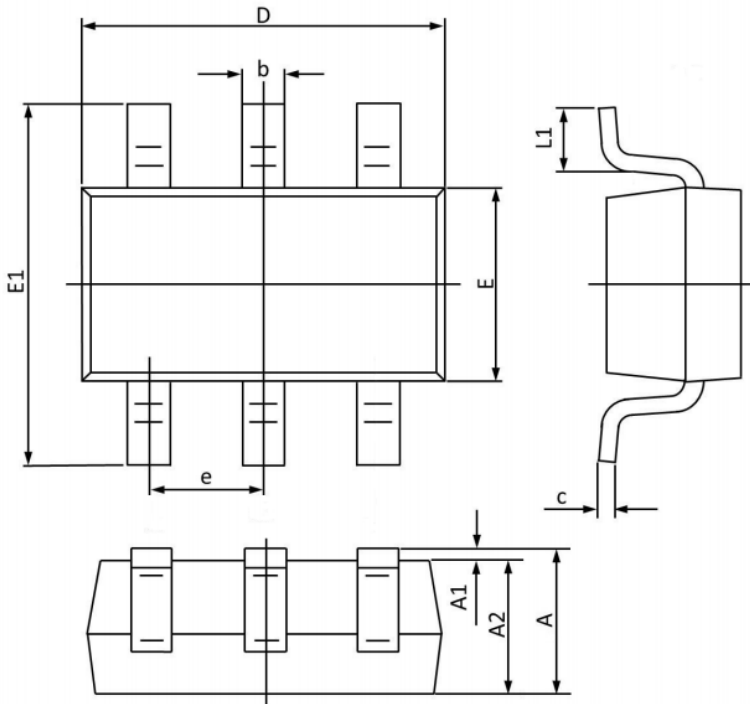


Figure 10. Switching Time Test Circuit and Waveforms

Package Outline Dimensions SOT-363



| Symbol | Dimensions in Millimeters | | Dimensions in Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 0.800 | 1.100 | 0.031 | 0.043 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 0.800 | 1.000 | 0.031 | 0.039 |
| b | 0.100 | 0.330 | 0.004 | 0.013 |
| c | 0.100 | 0.250 | 0.004 | 0.010 |
| D | 1.800 | 2.200 | 0.071 | 0.087 |
| E | 1.150 | 1.350 | 0.045 | 0.053 |
| E1 | 1.800 | 2.400 | 0.071 | 0.094 |
| e | 0.65 BSC | | 0.026 BSC | |
| L1 | 0.100 | 0.350 | 0.004 | 0.014 |

Order Information

| Device | Package | Marking Code | Quantity | HSF Status |
|-----------|---------|--------------|-----------------|----------------|
| GSFK0501E | SOT-363 | 84K | 3000 pcs / Reel | RoHS Compliant |